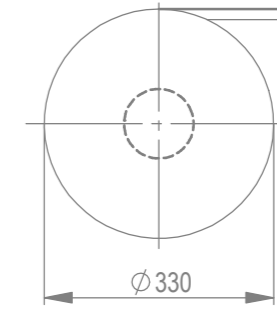
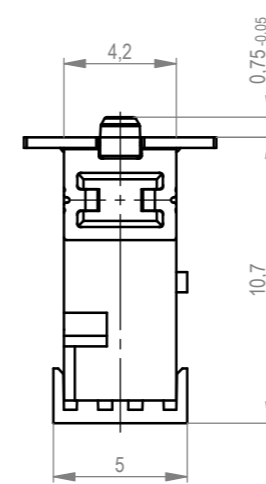
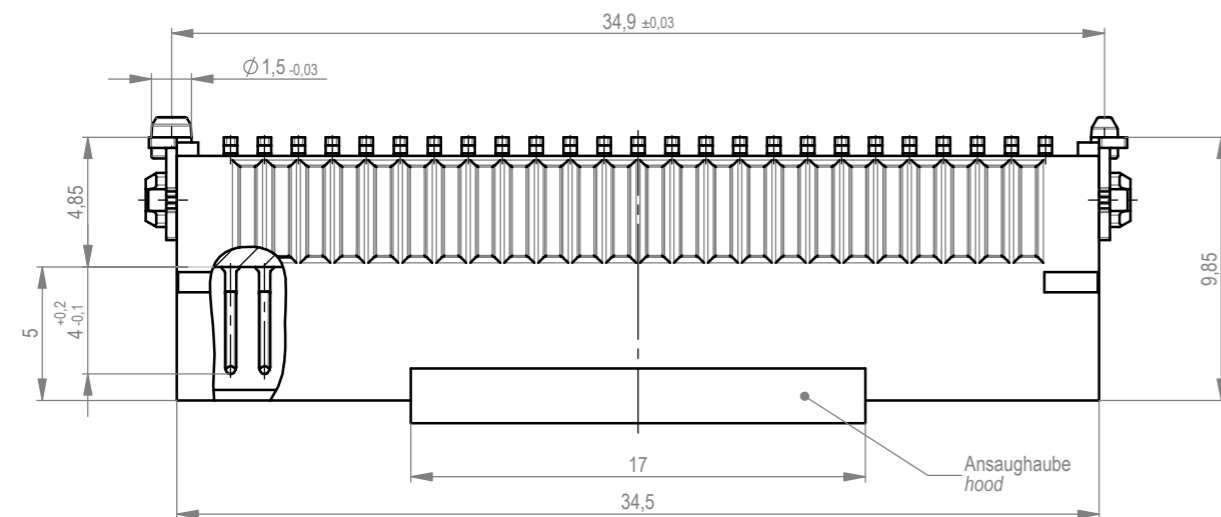
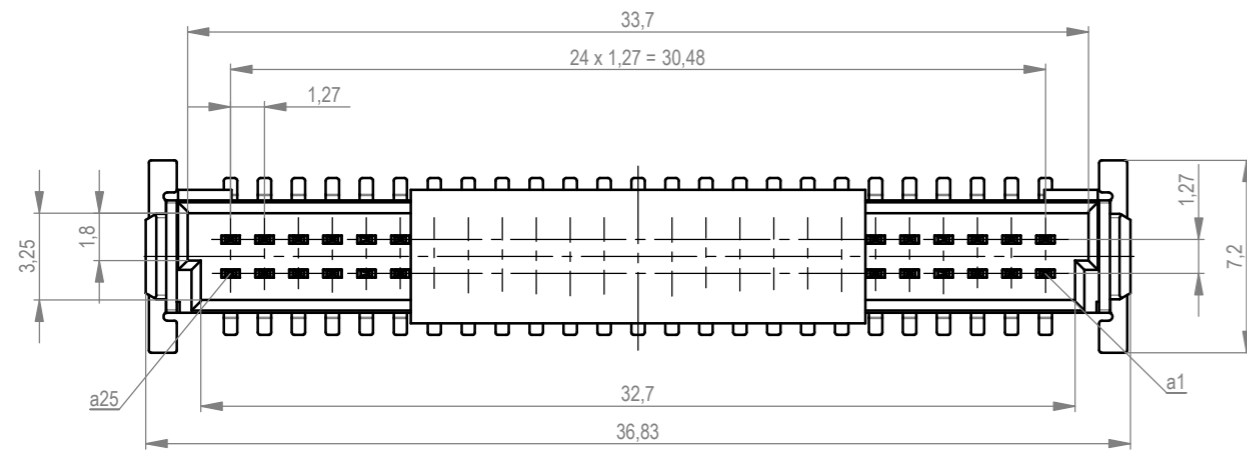
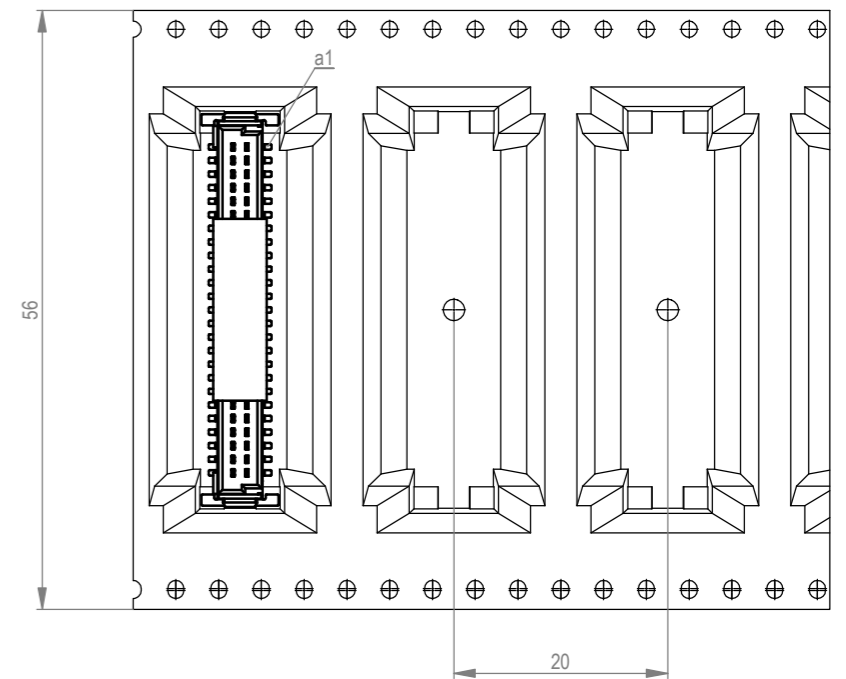


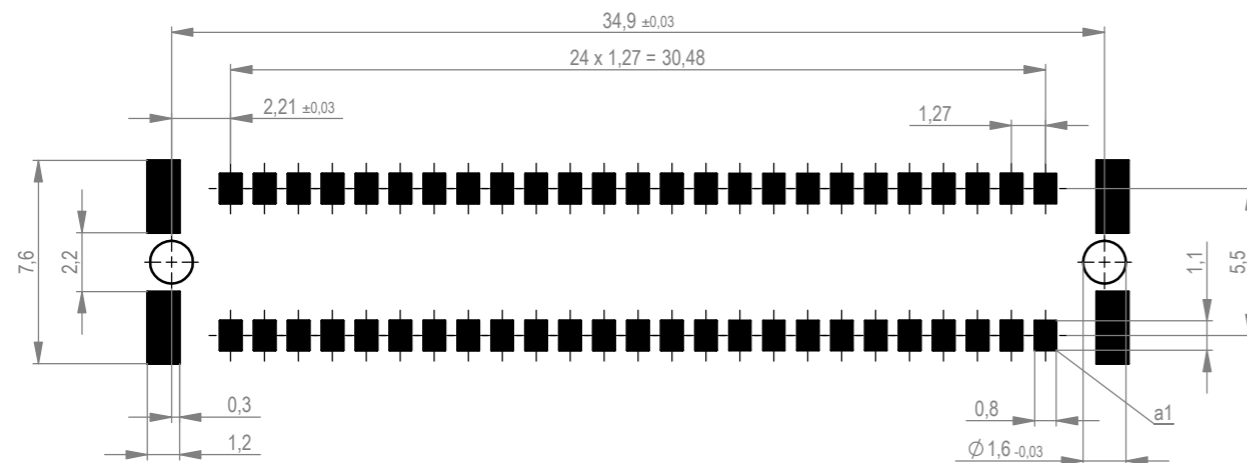
Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
 tape on reel packaging according to DIN IEC 60286-3
 Verpackungseinheit: 250 Stück
 packaging unit: 250 pcs



Abspulrichtung - reel off direction



Leiterplatten-Layout Vorschlag für SMT
 PCB-Layout Proposal for SMT



Anforderungsstufe 1
 performance level 1

Kontaktbereich vergoldet
 mating area gold plating

Anschlussbereich verzinkt 4-6 µm
 terminal area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
 coplanarity area of termination ≤ 0,1 mm

BA 8-23 - hohe Bauhöhe
 type 8-23 - High Profile

Dimension no.	Tolerances Dim. for Information ISO 8015	Scale 5:1 Material	ERNI-SMC Male Connector Q SMT Type 8-23 50p C-234208-E
Customer drawing: This Drawing is a controlled Document.	Subject to modification without prior notice. Drawing will not be updated.	TE Connectivity	
J Index	18.02.2025 Date	Class SMCQ	C A2

Wichtige Hinweise: Diese Zeichnung ist nur zur Erleichterung der Herstellung. Bei Abweichungen von dem englischen Original gilt das englische Original. This drawing has been created for convenience only and may deviate from the original. In case of any deviation the English version shall prevail.